

## Features

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$



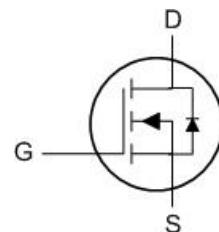
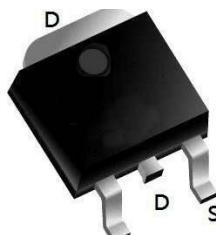
## Product Summary

BVDSS	RDS(on)	ID
100V	20 mΩ	40A

## Applications

- DC-DC Converters
- Power management functions
- Synchronous-rectification applications

## TO252 Pin Configuration



## Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter		Max.	Units
$V_{DSS}$	Drain-Source Voltage		100	V
$V_{GSS}$	Gate-Source Voltage		$\pm 20$	V
$I_D$	Continuous Drain Current <sup>note5</sup>	$T_c = 25^\circ\text{C}$	40	A
$I_D$	Continuous Drain Current <sup>note5</sup>	$T_c = 100^\circ\text{C}$	16	A
$I_{DM}$	Pulsed Drain Current <sup>note3</sup>		100	A
$P_D$	Power Dissipation <sup>note2</sup>	$T_c = 25^\circ\text{C}$	27	W
$I_{AS}$	Avalanche Current <sup>note3,6</sup>		8	A
$E_{AS}$	Single Pulse Avalanche Energy <sup>note3,6</sup>		16	mJ
$R_{θJC}$	Thermal Resistance, Junction to Case		4.65	$^\circ\text{C}/\text{W}$
$R_{θJA}$	Thermal Resistance, Junction to Ambient <sup>note1,4</sup>		62	$^\circ\text{C}/\text{W}$
$T_J, T_{STG}$	Operating and Storage Temperature Range		-55 to +150	$^\circ\text{C}$

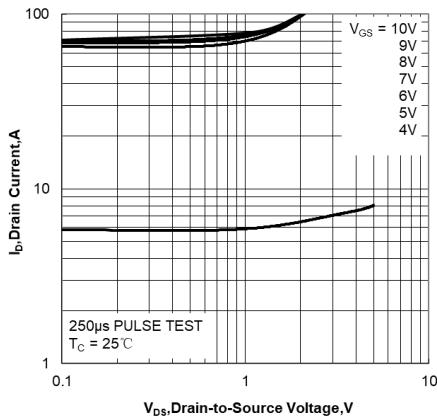
**Electrical Characteristics**  $T_c=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0\text{V}$ , $I_{\text{D}} = 250\mu\text{A}$	100	-	-	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}} = 80\text{V}$ , $V_{\text{GS}} = 0\text{V}$	-	-	1	$\mu\text{A}$
$I_{\text{GSS}}$	Gate to Body Leakage Current	$V_{\text{DS}} = 0\text{V}$ , $V_{\text{GS}} = \pm 20\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b>						
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}$ , $I_{\text{D}} = 250\mu\text{A}$	1.2	1.8	2.6	V
$R_{\text{DS}(\text{on})}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10\text{V}$ , $I_{\text{D}} = 15\text{A}$	-	20	23	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}$ , $I_{\text{D}} = 10\text{A}$	-	-	33	$\text{m}\Omega$
$\text{g}_{\text{fs}}$	Forward Threshold Voltage	$V_{\text{DS}} = 10\text{V}$ , $I_{\text{D}} = 20\text{A}$	-	22	-	S
$R_g$	Gate Resistance	$V_{\text{DS}} = V_{\text{GS}} = 0\text{V}$ , $f = 1.0\text{MHz}$	-	1.62	-	$\Omega$
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 50\text{V}$ , $V_{\text{GS}} = 0\text{V}$ , $f = 1.0\text{MHz}$	-	822	-	pF
$C_{\text{oss}}$	Output Capacitance		-	310	-	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		-	23.5	-	pF
<b>Switching Characteristics</b>						
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 50\text{V}$ , $I_{\text{D}} = 20\text{A}$ , $V_{\text{GS}} = 10\text{V}$	-	22.7	-	nC
$Q_{\text{gs}}$	Gate-Source Charge		-	6.2	-	
$Q_{\text{gd}}$	Gate-Drain("Miller") Charge		-	5.3	-	
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{DS}} = 50\text{V}$ , $I_{\text{D}} = 20\text{A}$ , $R_G = 3\Omega$ , $V_{\text{GS}} = 10\text{V}$	-	15	-	ns
$t_r$	Turn-On Rise Time		-	3.2	-	
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time		-	30	-	
$t_f$	Turn-Off Fall Time		-	7.6	-	
<b>Diode Characteristics</b>						
$I_s$	Continuous Source Current		-	-	40	A
$V_{\text{SD}}$	Diode Forward Voltage	$I_s = 20\text{A}$ , $V_{\text{GS}} = 0\text{V}$	-	0.88	1.0	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_{\text{SD}} = 20\text{A}$ , $dI_{\text{SD}}/dt = 100\text{A}/\mu\text{s}$	-	45	-	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		-	59	-	nC

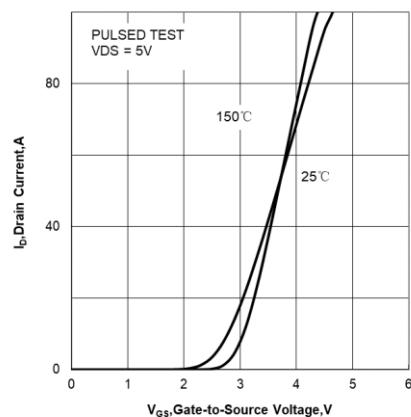
Notes:

- The value of  $R_{\theta_{JC}}$  is measured in a still air environment with  $TA = 25^\circ\text{C}$  and the maximum allowed junction temperature of  $150^\circ\text{C}$ . The value in any given application depends on the user's specific board design.
- The power dissipation  $P_D$  is based on  $T_{J(\text{MAX})}=150^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- Single pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{C}$ .
- The  $R_{\theta_{JA}}$  is the sum of the thermal impedance from junction to case  $R_{\theta_{JC}}$  and case to ambient.
- The maximum current rating is package limited.
- The EAS data shows Max. rating. The test condition is  $V_{\text{DS}}=50\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.5\text{mH}$

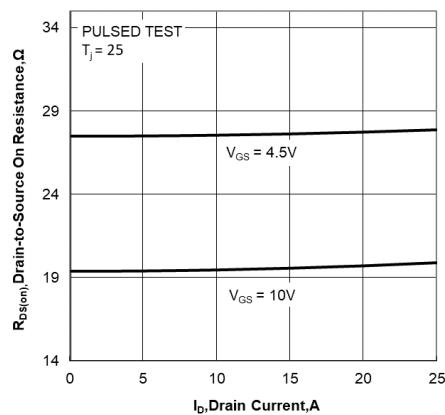
## Typical Performance Characteristics



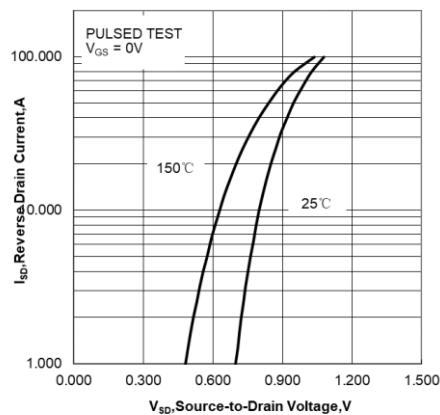
**Figure 1. Output Characteristics**



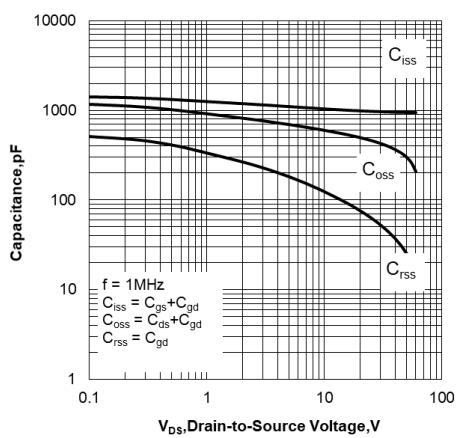
**Figure 2. Transfer Characteristics**



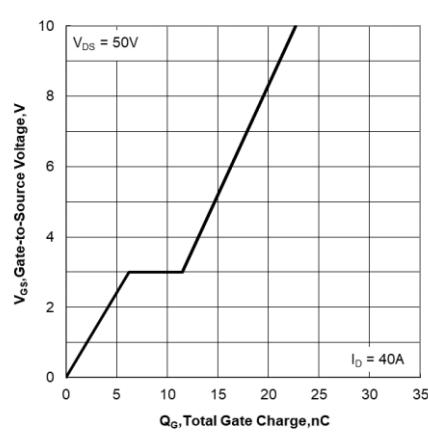
**Figure 3. Drain-to-Source On Resistance  
vs Drain Current**



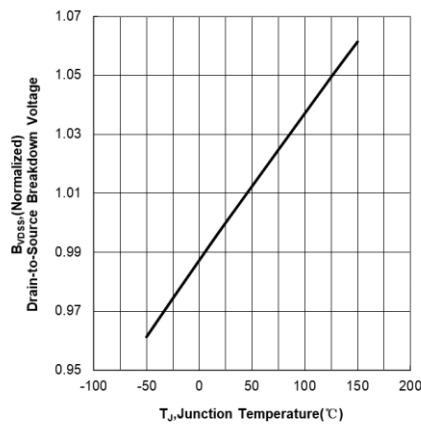
**Figure 4. Body Diode Forward Voltage  
vs Source Current and Temperature**



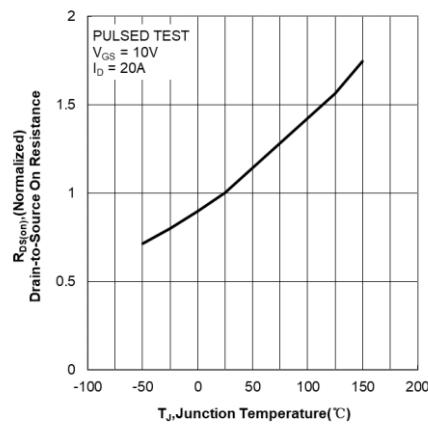
**Figure 5. Capacitance Characteristics**



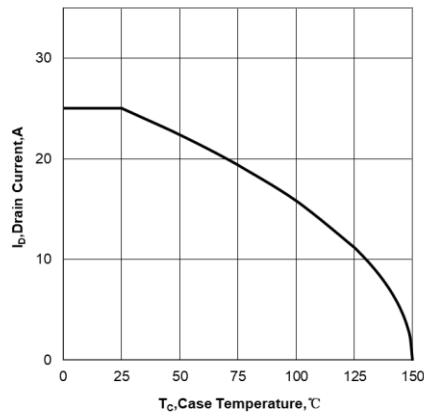
**Figure 6. Gate Charge Characteristics**



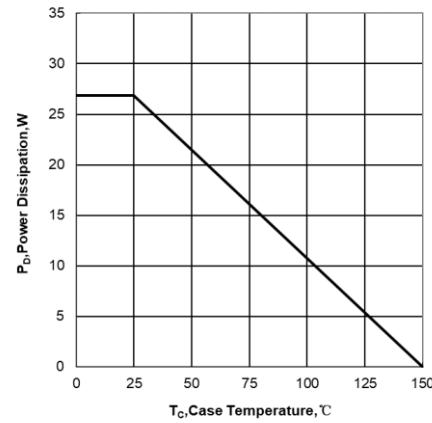
**Figure 7. Normalized Breakdown Voltage  
vs Junction Temperature**



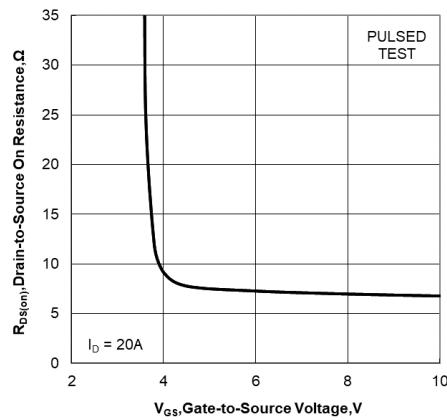
**Figure 8. Normalized On Resistance vs  
Junction Temperature**



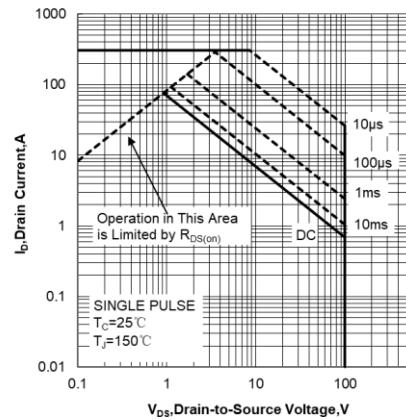
**Figure 9. Maximum Continuous Drain Current  
vs Case Temperature**



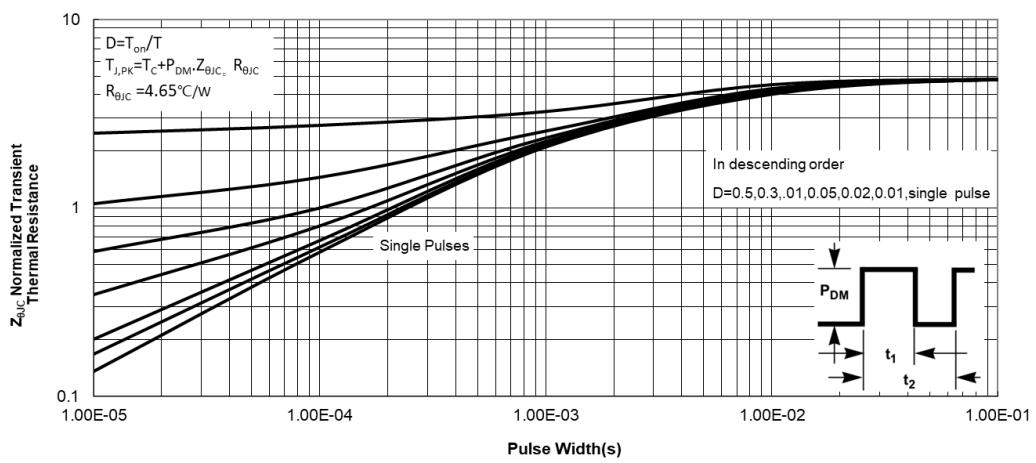
**Figure 10. Maximum Power Dissipation  
vs Case Temperature**



**Figure11. Drain-to-Source On Resistance vs Gate**

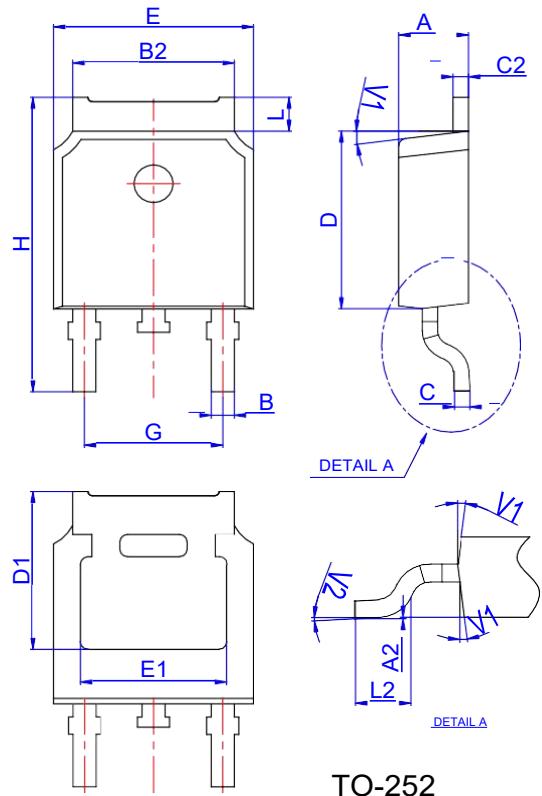


**Figure 12. Maximum Safe Operating Area**



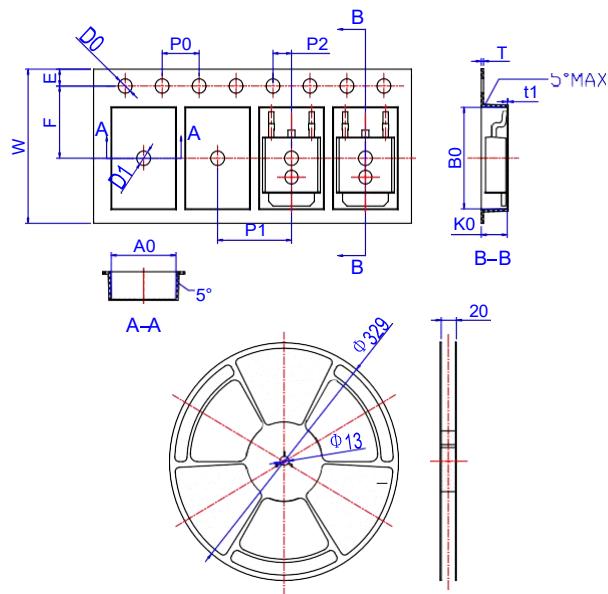
**Figure 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case**

## Package Mechanical Data TO 252



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

## Reel Specification-TO-252-4R



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583